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FAIRCHILD

SEMICONDUCTOR®

FQPF7P06 **60V P-Channel MOSFET**

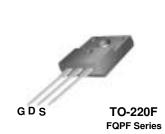
General Description

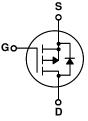
These P-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand a high energy pulse in the avalanche and commutation modes. These devices are well suited for low voltage applications such as automotive, DC/DC converters, and high efficiency switching for power management in portable and battery operated products.

Features

- 5.3A, -60V, $R_{DS(on)}$ = 0.41 Ω @V_{GS} = -10 V Low gate charge (typical 6.3 nC)
- Low Crss (typical 25 pF) •
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability
- 175°C maximum junction temperature rating





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter		FQPF7P06	Units
V _{DSS}	Drain-Source Voltage		-60	V
I _D	Drain Current - Continuous ($T_C = 25^{\circ}C$)		-5.3	А
	- Continuous (T _C = 100°C)		-3.75	А
I _{DM}	Drain Current - Pulsed	(Note 1)	-21.2	Α
V _{GSS}	Gate-Source Voltage		± 25	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	90	mJ
I _{AR}	Avalanche Current	(Note 1)	-5.3	А
E _{AR}	Repetitive Avalanche Energy	(Note 1)	2.4	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		-7.0	V/ns
PD	Power Dissipation (T _C = 25°C)		24	W
	- Derate above 25°C		0.16	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +175	°C
ΤL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

Thermal Characteristics

Symbol	Parameter	Тур	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		6.2	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction-to-Ambient		62.5	°C/W

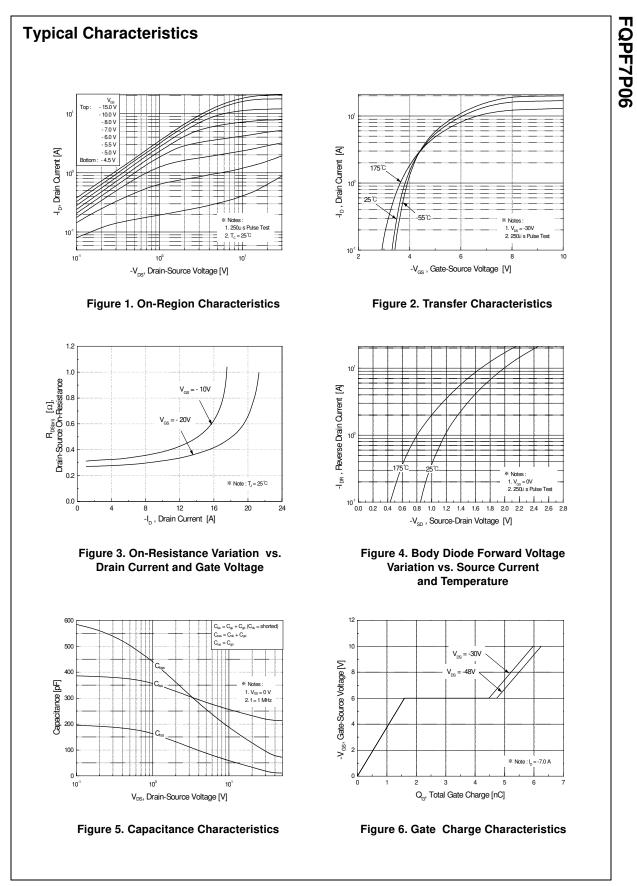
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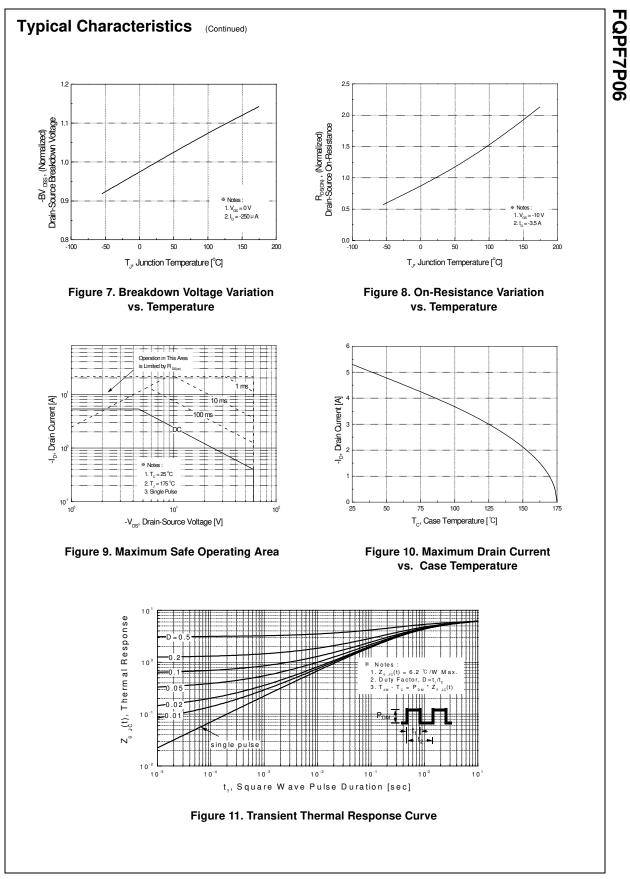
May 2001 FET™

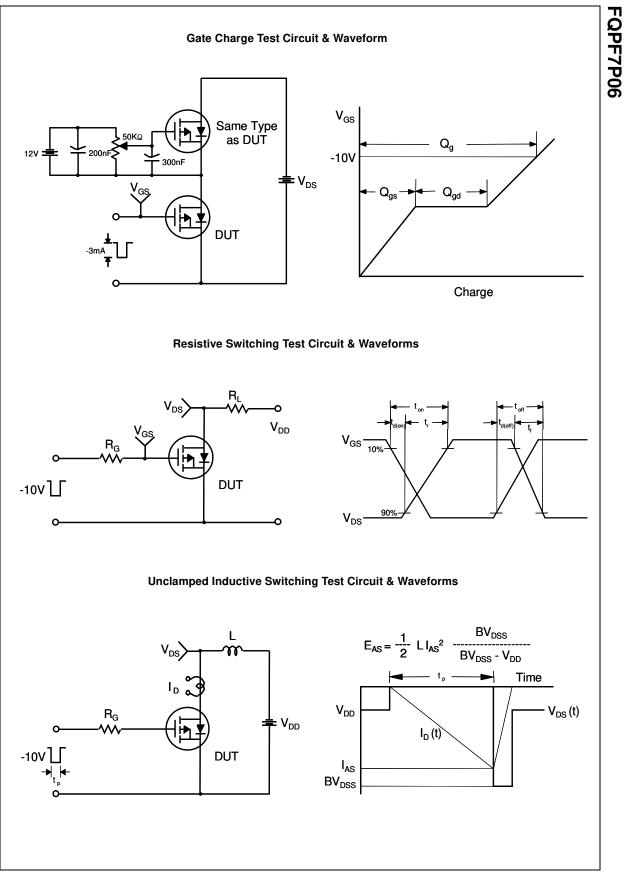
	Parameter	Test Conditions	Min	Тур	Max	Units
Off Cha	racteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = -250 \mu A$	-60			V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu A$, Referenced to 25°C		-0.07		V/°C
I _{DSS}	Zan Oala Malla a Davia Oanaal	$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}$			-1	μA
	Zero Gate Voltage Drain Current	V _{DS} = -48 V, T _C = 150°C			-10	μA
I _{GSSF}	Gate-Body Leakage Current, Forward	$V_{GS} = -25 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	$V_{GS} = 25 \text{ V}, V_{DS} = 0 \text{ V}$			100	nA
On Cha	racteristics					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-2.0		-4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = -10 V, I _D = -2.65 A		0.32	0.41	Ω
9 _{FS}	Forward Transconductance	$V_{DS} = -30 \text{ V}, I_D = -2.65 \text{ A}$ (Note 4)		3.7		S
C _{iss} C _{oss} C _{rss}	Output Capacitance Reverse Transfer Capacitance	V _{DS} = -25 V, V _{GS} = 0 V, f = 1.0 MHz		110 25	145 32	pF pF
Ļ	ng Characteristics					P.
Owneen	Turn-On Delay Time	V 00.V/L 0.5 A		7	25	ns
1		V _{DD} = -30 V, I _D = -3.5 A,		50	110	ns
t _{d(on)} t _r	Turn-On Rise Time	$P_{-} = 25.0$			05	
t _{d(on)} t _r	Turn-On Rise Time Turn-Off Delay Time	$R_{G} = 25 \Omega$		7.5	25	ns
t _{d(on)} t _r t _{d(off)}		$R_G = 25 \Omega$ (Note 4, 5)			25 60	ns ns
t _{d(on)} t _r t _{d(off)} t _f	Turn-Off Delay Time	(Note 4, 5)		7.5	-	
t _{d(on)}	Turn-Off Delay Time Turn-Off Fall Time			7.5 25	60	ns

Notes: 1. Repetitive Rating : Pulse width limited by maximum junction temperature 2. L = 3.7mH, I_{AS} = -5.3A, V_{DD} = -25V, R_G = 25 Ω, Starting T_J = 25°C 3. I_{SD} \leq -7.0A, di/dt \leq 300A/µs, V_{DD} \leq BV_{DSS}, Starting T_J = 25°C 4. Pulse Test : Pulse width \leq 300µs, Duty cycle \leq 2% 5. Essentially independent of operating temperature

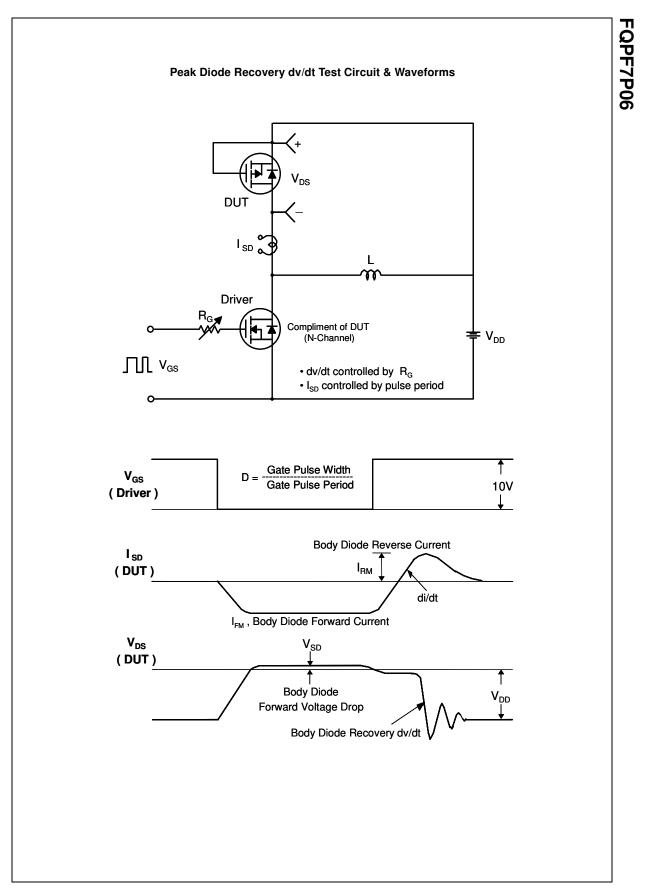


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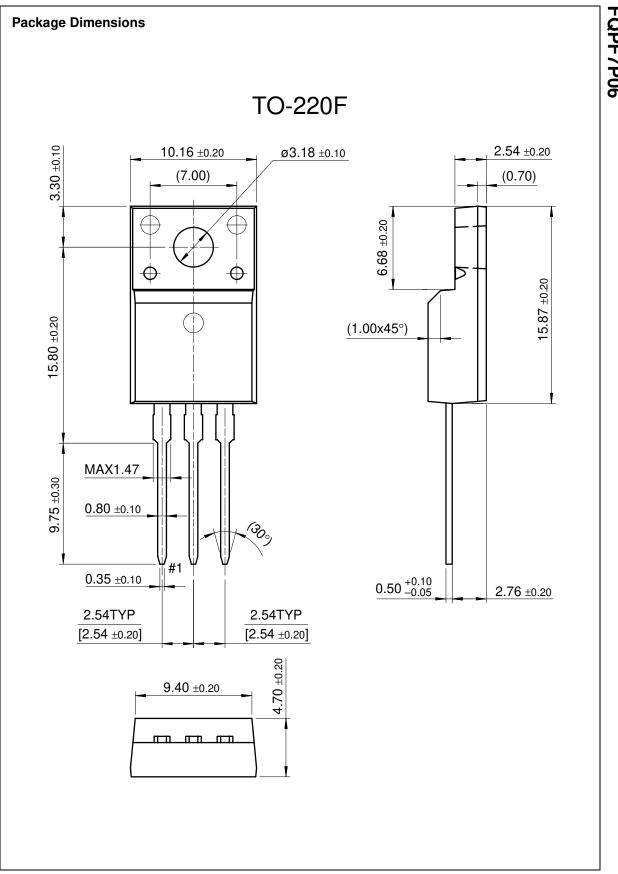




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